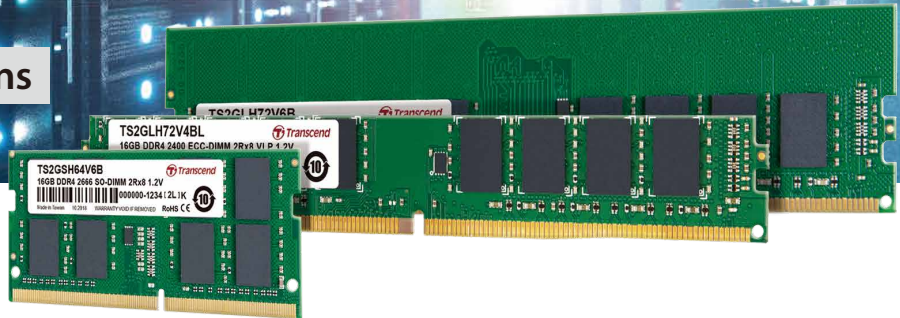




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Embedded Solutions





DRAM Modules DDR4

Transcend's DDR4 DRAM modules operate at a nominal voltage of just 1.2V, offering higher energy efficiency and exceptional clock speeds to cater to the demands of the embedded industry. The modules are available in multiple form factors and technologies, such as ECC and wide-temperature support. All components are of the highest quality, having been sourced directly from the world's first-tier supplier of DRAM chips and stringently tested for unparalleled compatibility, reliability, and performance.



Features

- JEDEC standard 1.2V ± 0.06V power supply
- High energy efficiency
- 8 bit pre-fetch
- Burst Length: 4, 8
- 16 Banks (4 Bank Groups)
- Support DBI mode
- Support Command/Address parity detection
- Support Data Cyclic Redundancy Check (CRC) for improved data reliability
- On-die termination with ODT pin
- Serial presence detect with EEPROM
- 100% tested for stability, compatibility and performance

Advanced Technologies

 Anti-Sulfur Technology	 Corner Bond & Underfill	 Conformal Coating
 Wide Temperature	 30µm Gold Finger	

DDR4 Unbuffered DIMMs

Module Type	DDR4	
	Long-DIMM	SO-DIMM
Product Image		
Standard	JEDEC	
Speed	3200/2666/2400/2133 Mbps	
Capacity	2GB~32GB	
Voltage	1.2V	
Pin Count	Long-DIMM: 288 pin	SO-DIMM: 260 pin
PCB Height	Standard: 1.23 inches Very Low Profile: 0.74 inches	1.18 inches
Operating Temperature	Standard Temperature: 0°C~ 95°C Wide Temperature: -40°C~ 95°C	

Ordering Information

DDR4-3200 Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx16)x4	1Rx16	-	TS512MLH64V2D-I	-
4GB	(512Mx16)x4	1Rx16	TS512MLH64V2D3	-	-
8GB	(1Gx8)x8	1Rx8	TS1GLH64V2B	TS1GLH64V2B-I	-
8GB	(1Gx8)x8	1Rx8	TS1GLH64V2B-G	-	-
8GB	(1Gx8)x8	1Rx8	TS1GLH64V2B3	-	-
8GB	(1Gx16)x4	1Rx16	TS1GLH64V2G	TS1GLH64V2G-I	-
8GB	(1Gx16)x4	1Rx16	TS1GLH64V2G3	-	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V2B	TS2GLH64V2B-I	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V2B-G	-	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V2B3	-	-
16GB	(2Gx8)x8	1Rx8	TS2GLH64V2E	TS2GLH64V2E-I	-
16GB	(2Gx8)x8	1Rx8	TS2GLH64V2E3	-	-
32GB	(2Gx8)x16	2Rx8	TS4GLH64V2E	TS4GLH64V2E-I	-
32GB	(2Gx8)x16	2Rx8	TS4GLH64V2E-G	-	-
32GB	(2Gx8)x16	2Rx8	TS4GLH64V2E3	-	TS4GLH64V2E3L



DDR4-3200 SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx16)x4	1Rx16	TS512MSH64V2D3	-	-
8GB	(1Gx8)x8	1Rx8	-	TS1GSH64V2B2-I	-
8GB	(1Gx8)x8	1Rx8	TS1GSH64V2B-G	-	-
8GB	(1Gx8)x8	1Rx8	TS1GSH64V2B3	-	-
8GB	(1Gx8)x8	1Rx8	TS1GSH64V2B3-G	-	-
8GB	(1Gx16)x4	1Rx16	TS1GSH64V2G	TS1GSH64V2G-I	-
8GB	(1Gx16)x4	1Rx16	TS1GSH64V2G3	-	-
16GB	(1Gx8)x16	2Rx8	TS2GSH64V2B	TS2GSH64V2B-I	-
16GB	(1Gx8)x16	2Rx8	TS2GSH64V2B-G	-	-
16GB	(1Gx8)x16	2Rx8	TS2GSH64V2B3	-	-
16GB	(1Gx8)x16	2Rx8	TS2GSH64V2B3-G	-	-
16GB	(2Gx8)x8	1Rx8	TS2GSH64V2E	TS2GSH64V2E-I	-
16GB	(2Gx8)x8	1Rx8	TS2GSH64V2E3	-	-
32GB	(2Gx8)x16	2Rx8	TS4GSH64V2E	TS4GSH64V2E-I	-
32GB	(2Gx8)x16	2Rx8	TS4GSH64V2E-G	-	-
32GB	(2Gx8)x16	2Rx8	TS4GSH64V2E3	-	-

DDR4-2666 Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
2GB	(256Mx16)x4	1Rx16	TS256MLH64V6X	-	-
4GB	(512Mx16)x4	1Rx16	TS512MLH64V6D	-	-
4GB	(512Mx8)x8	1Rx8	TS512MLH64V6H	TS512MLH64V6H-I	TS512MLH64V6HL
8GB	(1Gx8)x8	1Rx8	TS1GLH64V6B	-	TS1GLH64V6BL
8GB	(1Gx8)x8	1Rx8	TS1GLH64V6B3	-	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V6B	TS2GLH64V6B-I	TS2GLH64V6BL
16GB	(1Gx8)x16	2Rx8	TS2GLH64V6B-G	-	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V6B3	-	-
32GB	(2Gx8)x16	2Rx8	TS4GLH64V6E	TS4GLH64V6E-I	TS4GLH64V6EL

DDR4-2666 SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)
2GB	(256Mx16)x4	1Rx16	TS256MSH64V6X	-
4GB	(512Mx16)x4	1Rx16	TS512MSH64V6D	-
4GB	(512Mx8)x8	1Rx8	TS512MSH64V6H	TS512MSH64V6H-I
8GB	(512Mx8)x16	2Rx8	TS1GSH64V6H	-
8GB	(1Gx8)x8	1Rx8	TS1GSH64V6B	TS1GSH64V6B-I
8GB	(1Gx8)x8	1Rx8	TS1GSH64V6B3	-
16GB	(1Gx8)x16	2Rx8	TS2GSH64V6B	TS2GSH64V6B-I
16GB	(1Gx8)x16	2Rx8	TS2GSH64V6B3	-
32GB	(2Gx8)x16	2Rx8	TS4GSH64V6E	TS4GSH64V6E-I
32GB	(2Gx8)x16	2Rx8	TS4GSH64V6E3	-

DDR4-2400 Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
2GB	(256Mx16)x4	1Rx16	-	-	TS256MLH64V4XL
4GB	(512Mx8)x8	1Rx8	TS512MLH64V4H	-	TS512MLH64V4HL
8GB	(512Mx8)x16	2Rx8	TS1GLH64V4H	-	-
8GB	(1Gx8)x8	1Rx8	TS1GLH64V4B	-	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V4B	-	TS2GLH64V4BL

DDR4-2400 SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)
2GB	(256Mx16)x4	1Rx16	TS256MSH64V4X	-
4GB	(512Mx8)x8	1Rx8	TS512MSH64V4H	TS512MSH64V4H-I
8GB	(512Mx8)x16	2Rx8	TS1GSH64V4H	-
8GB	(1Gx8)x8	1Rx8	TS1GSH64V4B	TS1GSH64V4B-I
16GB	(1Gx8)x16	2Rx8	TS2GSH64V4B	TS2GSH64V4B-I



DDR4-2133 Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x8	1Rx8	TS512MLH64V1H	-	-
8GB	(512Mx8)x16	2Rx8	TS1GLH64V1H	-	TS1GLH64V1HL
16GB	(1Gx8)x16	2Rx8	TS2GLH64V1B	-	-
16GB	(1Gx8)x16	2Rx8	TS2GLH64V1B-G	-	-

DDR4-2133 SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)
4GB	(512Mx8)x8	1Rx8	TS512MSH64V1H	TS512MSH64V1H-I
8GB	(512Mx8)x16	2Rx8	TS1GSH64V1H	TS1GSH64V1H-I
16GB	(1Gx8)x16	2Rx8	TS2GSH64V1B	TS2GSH64V1B-I

DDR4 ECC DIMMs

Module Type	DDR4	
	ECC Long-DIMM	ECC SO-DIMM
Product Image		
Standard	JEDEC	
Speed	3200/2666/2400/2133 Mbps	
Capacity	4GB~32GB	
Voltage	1.2V	
Pin Count	ECC Long-DIMM: 288 pin	ECC SO-DIMM: 260 pin
PCB Height	Standard: 1.23 inches Very Low Profile: 0.74 inches	1.18 inches
PCB Gold Finger Thickness	30μ"	
Anti-Sulfuration	Default	
Operating Temperature	Standard Temperature: 0°C~ 95°C Wide Temperature: -40°C~ 95°C	

Ordering Information

DDR4-3200 ECC Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
8GB	(1Gx8)x9	1Rx8	TS1GLH72V2B	TS1GLH72V2B-I	TS1GLH72V2BL
16GB	(1Gx8)x18	2Rx8	TS2GLH72V2B	TS2GLH72V2B-I	TS2GLH72V2BL
16GB	(1Gx8)x18	2Rx8	-	-	TS2GLH72V2B3L
16GB	(2Gx8)x9	1Rx8	TS2GLH72V2E	-	-
16GB	(2Gx8)x9	1Rx8	TS2GLH72V2E3	-	-
32GB	(2Gx8)x18	2Rx8	TS4GLH72V2E	TS4GLH72V2E-I	-
32GB	(2Gx8)x18	2Rx8	TS4GLH72V2E3	-	TS4GLH72V2E3L

DDR4-3200 ECC SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MSH72V2H	-	-
8GB	(1Gx8)x9	1Rx8	TS1GSH72V2B	TS1GSH72V2B-I	-
8GB	(1Gx8)x9	1Rx8	TS1GSH72V2B3	TS1GSH72V2B3-I	-
8GB	(512Mx8)x18	2Rx8	TS1GSH72V2H	TS1GSH72V2H-I	-
16GB	(1Gx8)x18	2Rx8	TS2GSH72V2B	TS2GSH72V2B-I	-
16GB	(2Gx8)x9	1Rx8	TS2GSH72V2E	-	-
16GB	(2Gx8)x9	1Rx8	TS2GSH72V2E3	TS2GSH72V2E3-I	-
32GB	(2Gx8)x18	2Rx8	TS4GSH72V2E	TS4GSH72V2E-I	-
32GB	(2Gx8)x18	2Rx8	TS4GSH72V2E3	TS4GSH72V2E3-I	-

DDR4-2666 ECC Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MLH72V6H	TS512MLH72V6H-I	TS512MLH72V6HL
8GB	(1Gx8)x9	1Rx8	TS1GLH72V6B	TS1GLH72V6B-I	TS1GLH72V6BL
8GB	(1Gx8)x9	1Rx8	TS1GLH72V6B3	-	-
16GB	(1Gx8)x18	2Rx8	TS2GLH72V6B	-	TS2GLH72V6BL
32GB	(2Gx8)x18	2Rx8	TS4GLH72V6E	TS4GLH72V6E-I	TS4GLH72V6EL

DDR4-2666 ECC SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)
4GB	(512Mx8)x9	1Rx8	TS512MSH72V6H	TS512MSH72V6H-I
8GB	(1Gx8)x9	1Rx8	TS1GSH72V6B	TS1GSH72V6B-I
16GB	(1Gx8)x18	2Rx8	TS2GSH72V6B	TS2GSH72V6B-I
32GB	(2Gx8)x18	2Rx8	TS4GSH72V6E	TS4GSH72V6E-I
32GB	(2Gx8)x18	2Rx8	TS4GSH72V6E3	-

DDR4-2400 ECC Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MLH72V4H	-	-
8GB	(1Gx8)x9	1Rx8	TS1GLH72V4B	-	-
16GB	(1Gx8)x18	2Rx8	TS2GLH72V4B	-	-
16GB	(1Gx8)x18	2Rx8	-	-	TS2GLH72V4B3L
32GB	(2Gx8)x18	2Rx8	TS4GLH72V4E	-	-

DDR4-2400 ECC SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)
4GB	(512Mx8)x9	1Rx8	TS512MSH72V4H	-
8GB	(512Mx8)x18	2Rx8	-	TS1GSH72V4H-I
8GB	(1Gx8)x9	1Rx8	TS1GSH72V4B	-
16GB	(1Gx8)x18	2Rx8	TS2GSH72V4B	TS2GSH72V4B-I


DDR4-2133 ECC Long-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MLH72V1H	-	-
8GB	(512Mx8)x18	2Rx8	TS1GLH72V1H	-	-
16GB	(1Gx8)x18	2Rx8	TS2GLH72V1B	-	-

DDR4-2133 ECC SO-DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~ 95°C)
4GB	(512Mx8)x9	1Rx8	TS512MSH72V1H	-
8GB	(512Mx8)x18	2Rx8	TS1GSH72V1H	TS1GSH72V1H-I
16GB	(1Gx8)x18	2Rx8	TS2GSH72V1B	TS2GSH72V1B-I

DDR4 Registered DIMMs

Module Type	DDR4 Registered DIMM
Product Image	
Standard	JEDEC
Speed	3200/2933/2666/2400/2133 Mbps
Capacity	4GB~32GB
Voltage	1.2V
Pin Count	R-DIMM: 288 pin
PCB Height	Standard: 1.23 inches Very Low Profile: 0.74 inches
PCB Gold Finger Thickness	30μ"
Anti-Sulfuration	Default
Operating Temperature	Standard Temperature: 0°C~95°C Wide Temperature: -40°C~95°C

Ordering Information

DDR4-3200 Registered DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~95°C)	Very Low Profile (VLP)
8GB	(1Gx8)x9	1Rx8	TS1GHR72V2B	-	-
8GB	(1Gx8)x9	1Rx8	TS1GHR72V2B3	-	-
16GB	(1Gx8)x18	2Rx8	TS2GHR72V2B	-	TS2GHR72V2BL
16GB	(2Gx8)x9	1Rx8	TS2GHR72V2E	TS2GHR72V2EL	-
32GB	(2Gx4)x36	2Rx4	TS4GHR72V2C	-	-
32GB	(2Gx8)x18	2Rx8	TS4GHR72V2E	TS4GHR72V2E-I	TS4GHR72V2EL
32GB	(2Gx8)x18	2Rx8	TS4GHR72V2E3	-	-
32GB	(2Gx4)x36	2Rx4	TS4GHR72V2C-SAM	-	-
64GB	(4Gx4)x36	2Rx4	TS8GHR72V2F-SAM	-	-

DDR4-2666 Registered DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MHR72V6H	-	-
8GB	(512Mx8)x18	2Rx8	TS1GHR72V6H	-	-
8GB	(1Gx8)x9	1Rx8	TS1GHR72V6B	-	-
16GB	(1Gx8)x18	2Rx8	TS2GHR72V6B	-	TS2GHR72V6BL
32GB	(2Gx4)x36	2Rx4	TS4GHR72V6C	-	-
32GB	(2Gx8)x18	2Rx8	-	TS4GHR72V6E-I	-

DDR4-2400 Registered DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MHR72V4H	-	-
8GB	(512Mx8)x18	2Rx8	-	-	TS1GHR72V4HL
8GB	(1Gx8)x9	1Rx8	TS1GHR72V4B	-	-
16GB	(1Gx8)x18	2Rx8	TS2GHR72V4B	-	TS2GHR72V4BL

DDR4-2133 Registered DIMM

Capacity	Component Composition	Rank x Org.	Standard (1.2V)	Wide Temp. (-40°C~95°C)	Very Low Profile (VLP)
4GB	(512Mx8)x9	1Rx8	TS512MHR72V1H	-	-
8GB	(512Mx8)x18	2Rx8	TS1GHR72V1H	-	TS1GHR72V1HL
16GB	(1Gx8)x18	2Rx8	TS2GHR72V1B	-	TS2GHR72V1BL

Product specifications are subject to change without notice. Pictures shown may differ from actual products. Due to the complexity and variety of industrial applications, Transcend cannot guarantee 100% compatibility with all platforms and under all scenarios. For special applications and environments, it is strongly suggested that you contact Transcend beforehand for clarification.



Please feel free to contact us with any special requests you might have.
Tel: +886-2-2792-8000 www.transcend-info.com



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US

sales@assured-systems.com

Sales: +1 347 719 4508
Support: +1 347 719 4508

1309 Coffeen Ave
Ste 1200
Sheridan
WY 82801
USA

EMEA

sales@assured-systems.com

Sales: +44 (0)1785 879 050
Support: +44 (0)1785 879 050

Unit A5 Douglas Park
Stone Business Park
Stone
ST15 0YJ
United Kingdom

VAT Number: 120 9546 28
Business Registration Number: 07699660